

Symposium (Oral) | Symposium : 【Open Symposium】 The Frontline of Materials, Processes, and Packaging Technologies Collaborating with State-of-the-Art Logic Semiconductors

📅 Mon. Sep 16, 2024 1:30 PM - 5:30 PM JST | Mon. Sep 16, 2024 4:30 AM - 8:30 AM UTC 🏢 A41 (TOKI MESSE 4F)

[16p-A41-1~9] (Open Symposium) The Frontline of Materials, Processes, and Packaging Technologies Collaborating with State-of-the-Art Logic Semiconductors

Keizo Kinoshita(AIO Core), Fumihiko Inoue(YNU)

1:30 PM - 1:35 PM JST | 4:30 AM - 4:35 AM UTC

[16p-A41-1] Opening

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Keywords : semiconductor